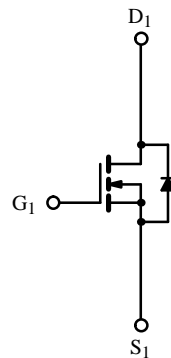
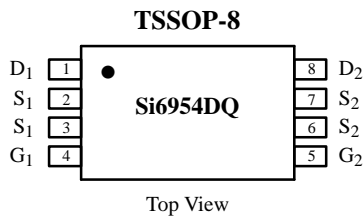


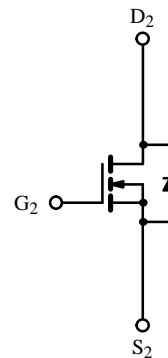
Dual N-Channel Enhancement-Mode MOSFET

Product Summary

| V _{DS} (V) | r _{DS(on)} (Ω) | I _D (A) |
|---------------------|---------------------------------|--------------------|
| 30 | 0.065 @ V _{GS} = 10 V | ± 3.9 |
| | 0.095 @ V _{GS} = 4.5 V | ± 3.1 |



N-Channel MOSFET



N-Channel MOSFET

Absolute Maximum Ratings (T_A = 25 °C Unless Otherwise Noted)

| Parameter | Symbol | Limit | Unit |
|---|-----------------------------------|------------------------|-------|
| Drain-Source Voltage | V _{DS} | 30 | V |
| Gate-Source Voltage | V _{GS} | ± 20 | |
| Continuous Drain Current (T _J = 150 °C) ^a | I _D | T _A = 25 °C | ± 3.9 |
| | | T _A = 70 °C | ± 3.1 |
| Pulsed Drain Current | I _{DM} | ± 20 | A |
| Continuous Source Current (Diode Conduction) ^a | I _S | 1.25 | |
| Maximum Power Dissipation ^a | P _D | T _A = 25 °C | 1.0 |
| | | T _A = 70 °C | 0.64 |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -55 to 150 | °C |

Thermal Resistance Ratings

| Parameter | Symbol | Limit | Unit |
|--|-------------------|-------|------|
| Maximum Junction-to-Ambient ^a | R _{thJA} | 125 | °C/W |

Notes

a. Surface Mounted on FR4 Board, t ≤ 10 sec.

Subsequent updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #1812.

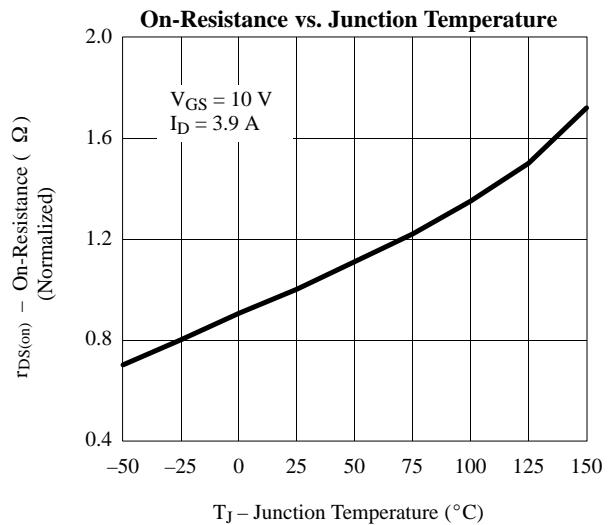
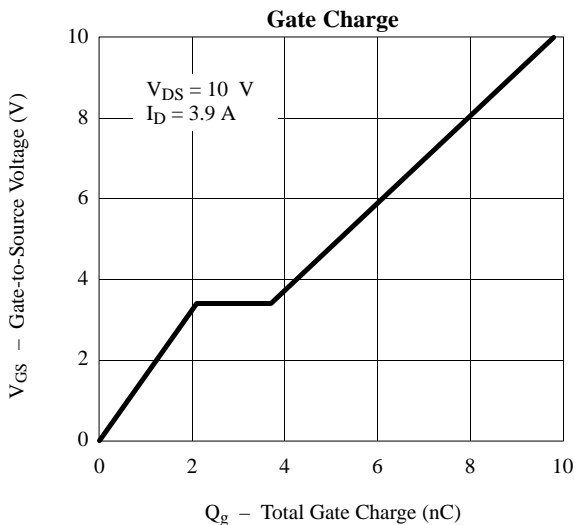
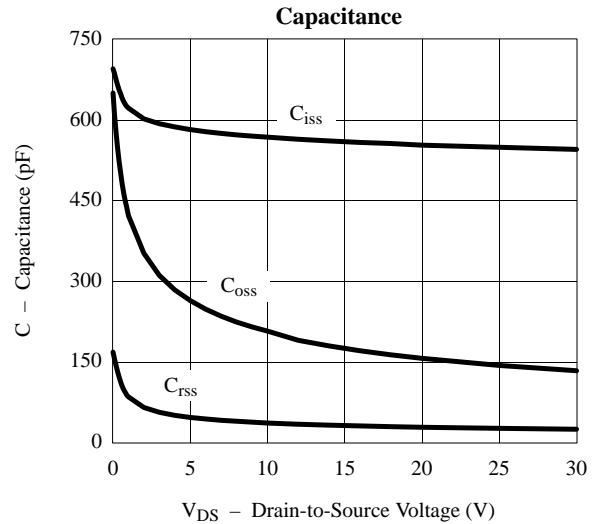
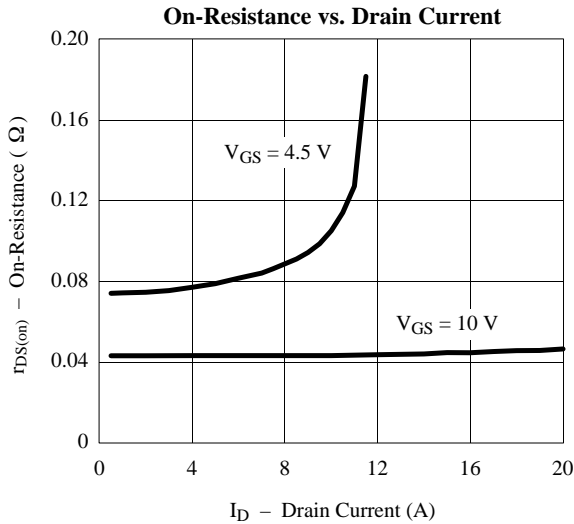
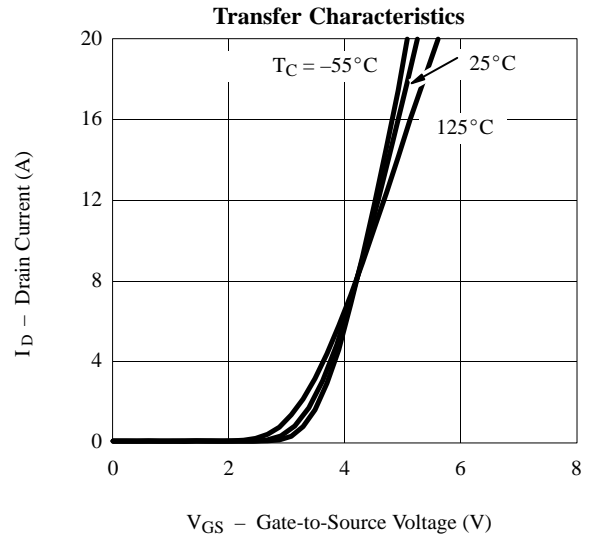
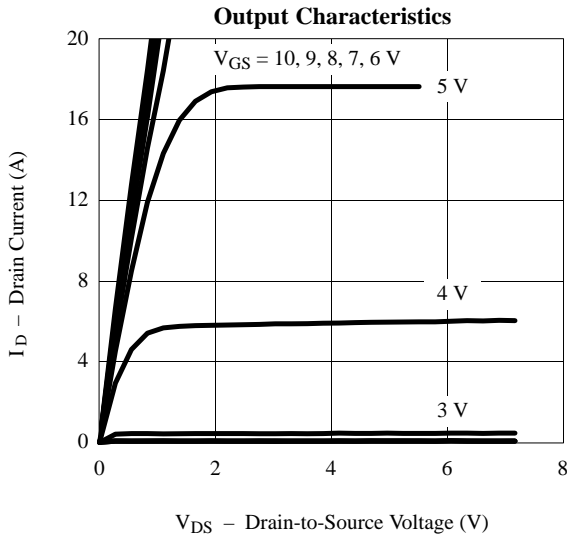
Specifications ($T_J = 25^\circ\text{C}$ Unless Otherwise Noted)

| Parameter | Symbol | Test Condition | Min | Typ | Max | Unit |
|---|--------------|---|-----|-------|-----------|---------------|
| Static | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ | 1.0 | | | V |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | μA |
| | | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$ | | | 25 | |
| On-State Drain Current ^a | $I_{D(on)}$ | $V_{DS} \geq 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 15 | | | A |
| Drain-Source On-State Resistance ^a | $r_{DS(on)}$ | $V_{GS} = 10 \text{ V}, I_D = 3.9 \text{ A}$ | | 0.043 | 0.065 | Ω |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 3.1 \text{ A}$ | | 0.075 | 0.095 | |
| Forward Transconductance ^a | g_{fs} | $V_{DS} = 15 \text{ V}, I_D = 3.9 \text{ A}$ | | 7.0 | | S |
| Diode Forward Voltage ^a | V_{SD} | $I_S = 1.25 \text{ A}, V_{GS} = 0 \text{ V}$ | | 0.77 | 1.2 | V |
| Dynamic^b | | | | | | |
| Total Gate Charge | Q_g | $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.9 \text{ A}$ | | 9.8 | 15 | nC |
| Gate-Source Charge | Q_{gs} | | | 2.1 | | |
| Gate-Drain Charge | Q_{gd} | | | 1.6 | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 10 \text{ V}, R_L = 10 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 6 \Omega$ | | 9 | 15 | ns |
| Rise Time | t_r | | | 6 | 12 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 18 | 27 | |
| Fall Time | t_f | | | 6 | 12 | |
| Source-Drain Reverse Recovery Time | t_{rr} | $I_F = 1.25 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$ | | 48 | 80 | |

Notes

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

Typical Characteristics (25°C Unless Otherwise Noted)



Typical Characteristics (25°C Unless Otherwise Noted)

